

MR1957-1472

SPW



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : Mei-Hung Hsu :

Serial No. : 10/774,427 :

Filed : 10 February 2004

Patent No. : 6,998,280 :

Issued : 14 February 2006

Title : WAFER PACKAGING PROCESS OF PACKAGING  
LIGHT EMITTING DIODE

REQUEST FOR CHANGE OF ENTITY STATUS  
TO LARGE ENTITY

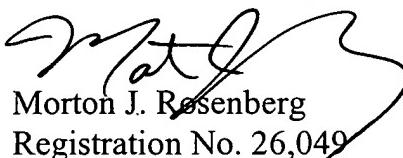
Mail Stop NO FEE  
Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Applicant, by the undersigned attorney hereby requests that the entity status of the above-referenced patent be changed to a "large entity". The Applicant has now become a large entity.

It is requested that the U.S. Patent and Trademark Office amend its records to show the fact that the patent status has been changed.

Respectfully submitted,  
FOR: ROSENBERG, KLEIN & LEE

  
Morton J. Rosenberg  
Registration No. 26,049

Dated: *10 March 2009*

Suite 101  
3458 Ellicott Center Drive  
Ellicott City, MD 21043  
Tel: 410-465-6678  
Customer No. 04586